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# **MC74VHC244**

# **Octal Bus Buffer**

The MC74VHC244 is an advanced high speed CMOS octal bus buffer fabricated with silicon gate CMOS technology.

The MC74VHC244 is a noninverting 3-state buffer, and has two active-low output enables. This device is designed to be used with 3-state memory address drivers, etc.

The internal circuit is composed of three stages, including a buffer output which provides high noise immunity and stable output. The inputs tolerate voltages up to 7 V, allowing the interface of 5 V systems to 3 V systems.

- High Speed:  $t_{PD} = 3.9$  ns (Typ) at  $V_{CC} = 5$  V
- Low Power Dissipation:  $I_{CC} = 4 \mu A$  (Max) at  $T_A = 25^{\circ}C$
- High Noise Immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Designed for 2 V to 5.5 V Operating Range
- Low Noise:  $V_{OLP} = 0.9 V (Max)$
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300 mA
- ESD Performance: Human Body Model > 2000 V Machine Model > 200 V
- Chip Complexity: 136 FETs
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

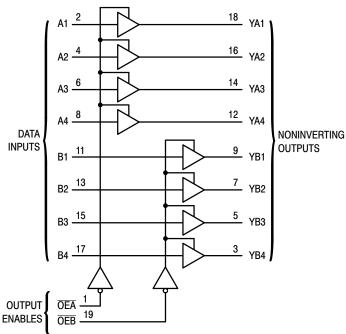


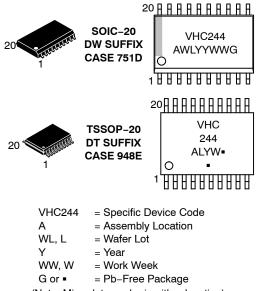
Figure 1. Logic Diagram



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Note: Microdot may	be in either location)
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PIN ASSIGNMENT					
	1•	20	vcc		
A1 [	2	19			
YB4 [	3	18	] YA1		
A2 [	4	17	] В4		
үвз [	5	16	] YA2		
A3 [	6	15	] вз		
YB2 [	7	14	] YA3		
A4 [	8	13	] B2		
YB1 [	9	12	] YA4		
GND [	10	11	] в1		
L					

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the Ordering Information Table on page 2 of this data sheet.

#### FUNCTION TABLE

INP	UTS	OUTPUTS
OEA, OEB	А, В	YA, YB
L	L	L
L	н	н
н	х	Z

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC74VHC244DWR2G	SOIC-20 WB (Pb-Free)	1000/Tape & Reel
MC74VHC244DTG		75 Units/Rail
MC74VHC244DTR2G	TSSOP-20 (Pb-Free)	2500/Tape & Reel
NLV74VHC244DTR2G*	()	2500/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

#### MAXIMUM RATINGS (Note 1)

Symbol	Pa	arameter	Value	Unit
V <sub>CC</sub>	Positive DC Supply Voltage		-0.5 to +7.0	V
V <sub>IN</sub>	Digital Input Voltage		-0.5 to +7.0	V
V <sub>OUT</sub>	DC Output Voltage		–0.5 to V <sub>CC</sub> +0.5	V
I <sub>IK</sub>	Input Diode Current		-20	mA
I <sub>OK</sub>	Output Diode Current		±20	mA
IOUT	DC Output Current, per Pin		±25	mA
I <sub>CC</sub>	DC Supply Current, $V_{CC}$ and GND Pins		±75	mA
P <sub>D</sub>	Power Dissipation in Still Air	SOIC TSSOP	500 450	mW
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
V <sub>ESD</sub>	ESD Withstand Voltage	Human Body Model (Note 2) Machine Model (Note 3) Charged Device Model (Note 4)	>2000 >200 >2000	V
ILATCHUP	Latchup Performance	Above $V_{CC}$ and Below GND at 125 $^{\circ}\text{C}$ (Note 5)	±300	mA
$\theta_{JA}$	Thermal Resistance, Junction-to-Ambi	ent SOIC TSSOP	96 128	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

V<sub>in</sub> and V<sub>out</sub> should be constrained to the range GND ≤ (V<sub>in</sub> or V<sub>out</sub>) ≤ V<sub>CC</sub>. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V<sub>CC</sub>). Unused outputs must be left open.

2. Tested to EIA/JESD22-A114-A

3. Tested to EIA/JESD22-A115-A

4. Tested to JESD22-C101-A

5. Tested to EIA/JESD78

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Characteristics			Max	Unit
V <sub>CC</sub>	DC Supply Voltage	2.0	5.5	V	
V <sub>IN</sub>	DC Input Voltage			5.5	V
V <sub>OUT</sub>	DC Output Voltage			V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature Range, all Package Types			125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Time	V <sub>CC</sub> = 3.3 V <u>+</u> 0.3 V V <sub>CC</sub> = 5.0 V <u>+</u> 0.5 V	0	100 20	ns/V

#### DEVICE JUNCTION TEMPERATURE VERSUS TIME TO 0.1% BOND FAILURES

Junction Temperature °C	Time, Hours	Time, Years
80	1,032,200	117.8
90	419,300	47.9
100	178,700	20.4
110	79,600	9.4
120	37,000	4.2
130	17,800	2.0
140	8,900	1.0

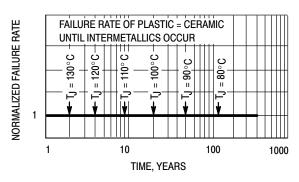


Figure 2. Failure Rate vs. Time Junction Temperature

			V <sub>cc</sub>	٦	Γ <sub>A</sub> = 25°0	C	<b>TA</b> ≤	85°C	–55°C ≤ T	A ≤ 125°C	
Symbol	Parameter	Condition	(V)	Min	Тур	Max	Min	Max	Min	Max	Unit
VIH	Minimum High–Level		2.0	1.5			1.5	1.5	1.5		V
	Input Voltage		3.0 to 5.5	V <sub>CCX</sub> 0.7			V <sub>CCX</sub> 0.7	V <sub>CCX</sub> 0.7	V <sub>CCX</sub> 0.7		
V <sub>IL</sub>	Maximum Low-Level		2.0			0.5		0.5		0.5	V
	Input Voltage		3.0 to 5.5			V <sub>CCX</sub> 0.3		V <sub>CCX</sub> 0.3		V <sub>CCX</sub> 0.3	
V <sub>OH</sub>	Maximum High-Level Output Voltage		2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5		1.9 2.9 4.4		1.9 2.9 4.4		V
			3.0 4.5	2.58 3.94			2.48 3.8		2.34 3.66		
V <sub>OL</sub>	Maximum Low–Level Output Voltage	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OL} = 50 \ \mu\text{A}$	2.0 3.0 4.5		0.0 0.0 0.0	0.1 0.1 0.1		0.1 0.1 0.1		0.1 0.1 0.1	V
			3.0 4.5			0.36 0.36		0.44 0.44		0.52 0.52	
I <sub>IN</sub>	Input Leakage Current	$V_{IN}$ = 5.5 V or GND	0 to 5.5			±0.1		±1.0		±1.0	μA
I <sub>OZ</sub>	Maximum 3-State Leakage Current	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or } GND$	5.5			±0.25		±2.5		±2.5	μΑ
I <sub>CC</sub>	Maximum Quiescent Supply Current (per package)	$V_{IN} = V_{CC}$ or GND	5.5			4.0		40.0		40.0	μA

#### DC CHARACTERISTICS (Voltages Referenced to GND)

## **MC74VHC244**

#### AC ELECTRICAL CHARACTERISTICS (Input tr = tf = 3.0 ns)

					T <sub>A</sub> = 25°	с	T <sub>A</sub> ≤	85°C		C ≤ T <sub>A</sub> 25°C	
Symbol	Parameter	Test Condi	tions	Min	Тур	Max	Min	Max	Min	Max	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay, A to YA or	$V_{CC} = 3.3 \pm 0.3 \text{ V}$	C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		5.8 8.3	8.4 11.9	1.0 1.0	10.0 13.5	1.0 1.0	11.0 14.5	ns
	B to YB	$V_{CC} = 5.0 \pm 0.5 \text{ V}$	$C_L = 15 \text{ pF}$ $C_L = 50 \text{ pF}$		3.9 5.4	5.5 7.5	1.0 1.0	6.5 8.5	1.0 1.0	7.5 9.5	
t <sub>PZL</sub> , t <sub>PZH</sub>	Output Enable Time OEA to YA or	$V_{CC} = 3.3 \pm 0.3 \text{ V}$ $R_L = 1 \text{ k}\Omega$			6.6 9.1	10.6 14.1	1.0 1.0	12.5 16.0	1.0 1.0	13.5 17.0	ns
	OEB to YB	$V_{CC} = 5.0 \pm 0.5 \text{ V}$ $R_L = 1 \text{ k}\Omega$			4.7 6.2	7.3 9.3	1.0 1.0	8.5 10.5	1.0 1.0	9.5 11.5	
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Output Disable Time OEA to YA or OEB to YB	$V_{CC} = 3.3 \pm 0.3 \text{ V}$ $R_L = 1 \text{ k}\Omega$	C <sub>L</sub> = 50 pF		10.3	14.0	1.0	16.0	1.0	17.0	ns
		$V_{CC} = 5.0 \pm 0.5 \text{ V}$ $R_L = 1 \text{ k}\Omega$	C <sub>L</sub> = 50 pF		6.7	9.2	1.0	10.5	1.0	11.5	
t <sub>OSLH</sub> , t <sub>OSHL</sub>	Output to Output Skew	V <sub>CC</sub> = 3.3 ± 0.3 V (Note 6)	C <sub>L</sub> = 50 pF			1.5		1.5		1.5	ns
		V <sub>CC</sub> = 5.0 ± 0.5 V (Note 6)	C <sub>L</sub> = 50 pF			1.0		1.0		1.5	
C <sub>in</sub>	Maximum Input Capacitance				4	10		10		10	pF
C <sub>out</sub>	Maximum Three-State Output Capacitance (Output in High-Impedance State)				6						pF
							Typical	@ 25°C	, V <sub>CC</sub> = {	5.0V	

Power Dissipation Capacitance (Note 7)  $C_{\text{PD}}$ 19

6. Parameter guaranteed by design. t<sub>OSLH</sub> = |t<sub>PLHm</sub> - t<sub>PLHn</sub>|, t<sub>OSHL</sub> = |t<sub>PHLm</sub> - t<sub>PHLn</sub>|.
7. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>/8 (per bit). C<sub>PD</sub> is used to determine the no-load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.

pF

#### **NOISE CHARACTERISTICS** (Input $t_r = t_f = 3.0$ ns, $C_L = 50$ pF, $V_{CC} = 5.0$ V)

		T <sub>A</sub> = 25°C		
Symbol	Parameter	Тур	Max	Unit
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>	0.6	0.9	V
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>	-0.6	-0.9	V
V <sub>IHD</sub>	Minimum High Level Dynamic Input Voltage		3.5	V
V <sub>ILD</sub>	Maximum Low Level Dynamic Input Voltage		1.5	V

### MC74VHC244

#### SWITCHING WAVEFORMS

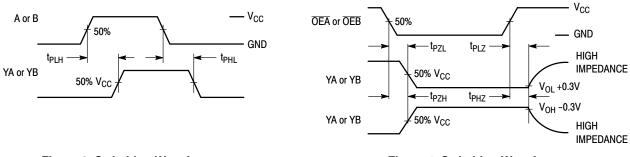
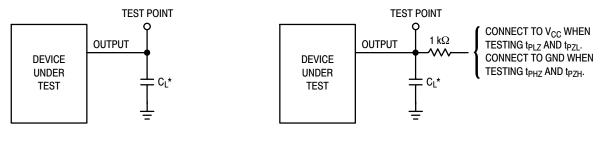




Figure 4. Switching Waveform





\*Includes all probe and jig capacitance

Figure 5. Test Circuit



\*Includes all probe and jig capacitance

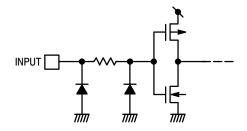
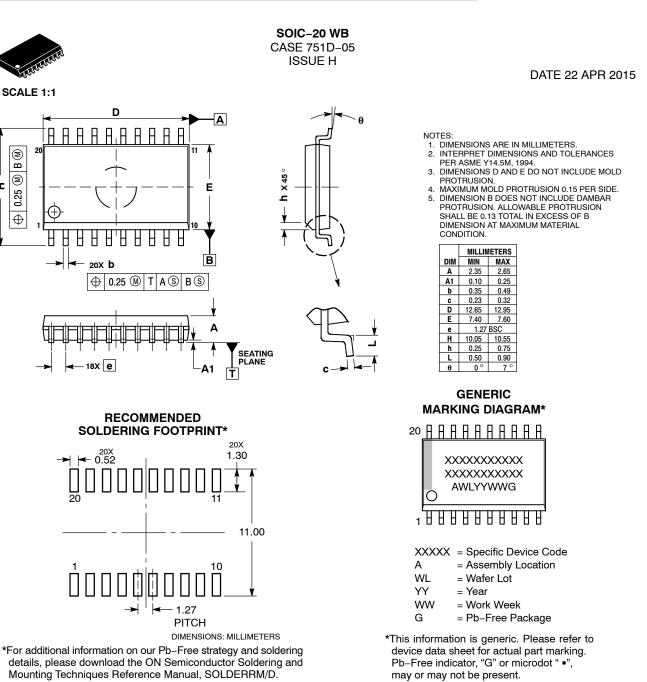


Figure 7. Input Equivalent Circuit

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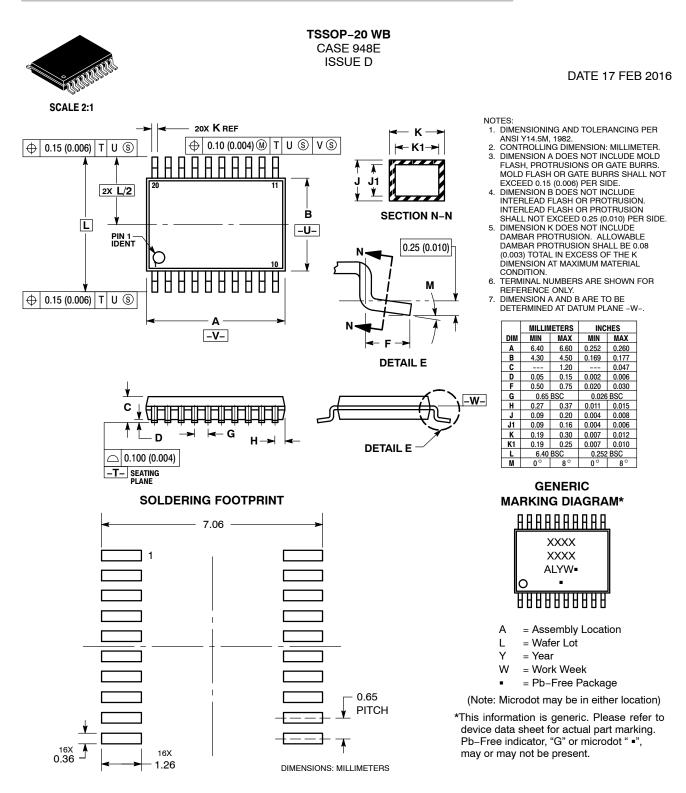
 

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